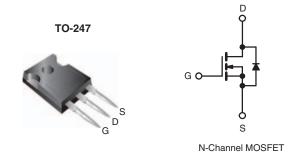


Vishay Siliconix

COMPLIANT

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	800	800		
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V	1.2		
Q _g (Max.) (nC)	200	200		
Q _{gs} (nC)	24	24		
Q _{gd} (nC)	110	110		
Configuration	Sing	Single		



FEATURES

- · Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Isolated Central Mounting Hole
- · Fast Switching
- · Ease of Paralleling
- · Simple Drive Requirements
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247
Lead (Pb)-free	IRFPE50PbF
Lead (Fb)-liee	SiHFPE50-E3
SnPb	IRFPE50
SIIFU	SiHFPE50

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V_{DS}	800	V	
Gate-Source Voltage	V_{GS}	± 20	1 °	
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 ^{\circ}C$	I _D	7.8	А
	$T_C = 100 ^{\circ}C$		4.9	
Pulsed Drain Current ^a	I _{DM}	31		
Linear Derating Factor		1.5	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	770	mJ	
Repetitive Avalanche Currenta	I _{AR}	7.8	A	
Repetitive Avalanche Energy ^a	E _{AR}	19	mJ	
Maximum Power Dissipation	T _C = 25 °C	P_{D}	190	W
Peak Diode Recovery dV/dt ^c	dV/dt	2.0	V/ns	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in
	0-32 OF IVIS SCIEW		1.1	N · m

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 23 mH, R_G = 25 Ω , I_{AS} = 7.8 A (see fig. 12).
- c. $I_{SD} \le 7.8 \text{ A}$, $dI/dt \le 140 \text{ A/}\mu\text{s}$, $V_{DD} \le 600 \text{ V}$, $T_J \le 150 \,^{\circ}\text{C}$.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFPE50, SiHFPE50

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.65	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		800	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.98	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} :	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	100 500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	1	_	_	1.2	Ω
Forward Transconductance	9fs		= 100 V, I _D = 4.7 A ^b	5.6	-	-	S
Dynamic	913	- 50					
Input Capacitance	C _{iss}		V 0V	_	3100	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	800	-	pF
Reverse Transfer Capacitance	C _{rss}			-	490	-	
Total Gate Charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 7.8 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 ^b		-	-	200	
Gate-Source Charge	Q _{gs}		-	-	24	nC	
Gate-Drain Charge	Q _{gd}		-	-	110		
Turn-On Delay Time	t _{d(on)}			-	19	-	ns
Rise Time	t _r		$V_{DD} = 400 \text{ V}, I_D = 7.8 \text{ A},$		38	-	
Turn-Off Delay Time	t _{d(off)}	$R_G = 6.2 \ \Omega, \ R_D = 52 \ \Omega$ see fig. 10^b		-	120	-	
Fall Time	t _f			ı	39	-	
Internal Drain Inductance	L_{D}	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	511
Internal Source Inductance	L _S			-	13	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7.8	_
Pulsed Diode Forward Current ^a	I _{SM}			-	-	31	A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 7.8 A, V _{GS} = 0 V ^b		-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 7.8 A, dl/dt = 100 A/μs ^b		-	650	980	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.8	5.7	μС
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

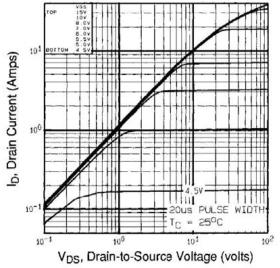


Fig. 1 - Typical Output Characteristics, $T_C = 25 \, ^{\circ}C$

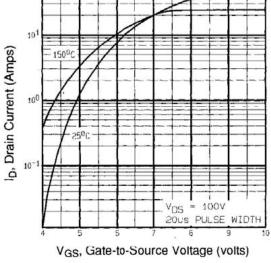


Fig. 3 - Typical Transfer Characteristics

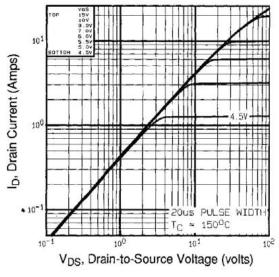


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

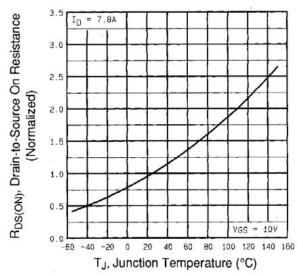


Fig. 4 - Normalized On-Resistance vs. Temperature

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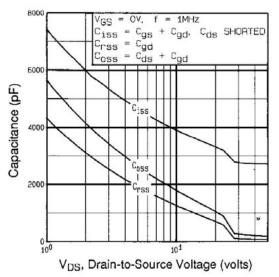


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

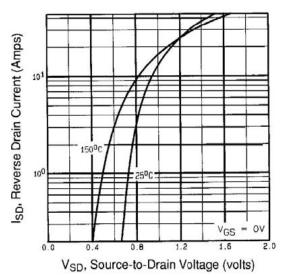


Fig. 7 - Typical Source-Drain Diode Forward Voltage

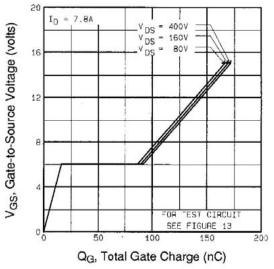


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

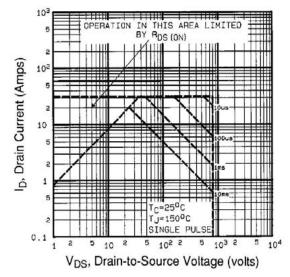


Fig. 8 - Maximum Safe Operating Area





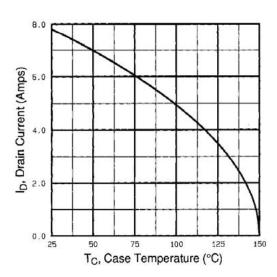


Fig. 9 - Maximum Drain Current vs. Case Temperature

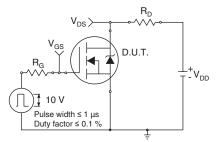


Fig. 10a - Switching Time Test Circuit

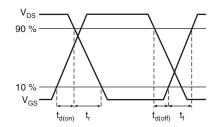


Fig. 10b - Switching Time Waveforms

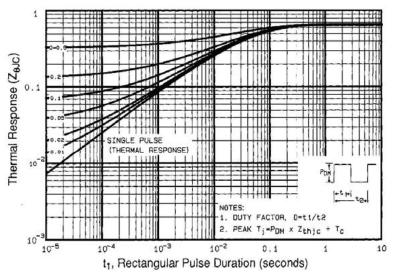


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

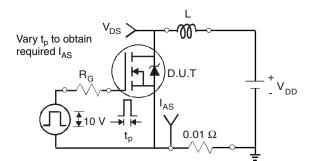


Fig. 12a - Unclamped Inductive Test Circuit

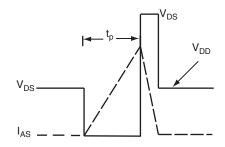


Fig. 12b - Unclamped Inductive Waveforms

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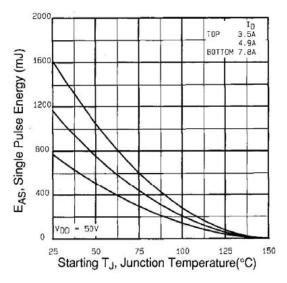


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

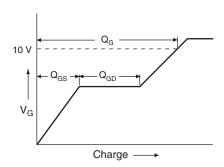


Fig. 13a - Basic Gate Charge Waveform

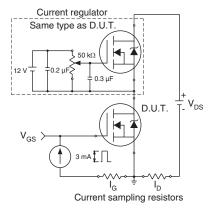
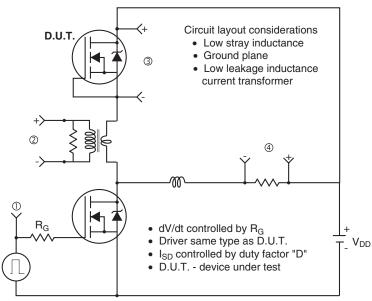
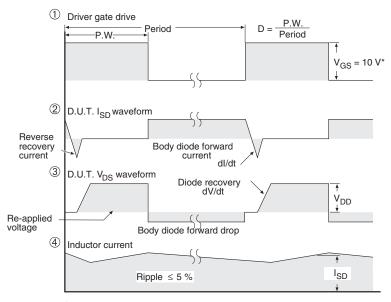


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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Document Number: 91248 S-81368-Rev. A, 21-Jul-08



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